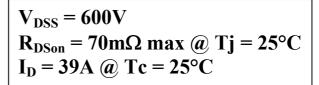
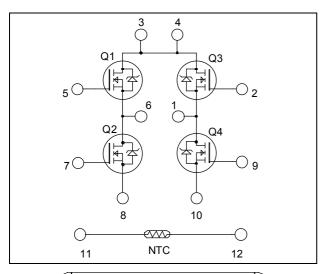
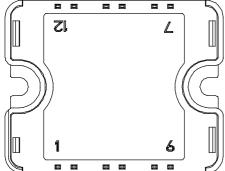


Full - Bridge Super Junction MOSFET Power Module







Pins 3/4 must be shorted together

Application

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

Features

• COOLMOS

- Ultra low R_{DSon}
- Low Miller capacitance
- Ultra low gate charge
- Avalanche energy rated
- Very rugged
- Very low stray inductance
 - Symmetrical design
- Internal thermistor for temperature monitoring
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- Each leg can be easily paralleled to achieve a phase leg of twice the current capability
- RoHS Compliant

Absolute maximum ratings

| Symbol | Parameter | | Max ratings | Unit |
|-------------------|---|---------------------|-------------|------|
| $V_{ m DSS}$ | Drain - Source Breakdown Voltage | | 600 | V |
| Ţ | Continuous Drain Current | $T_c = 25^{\circ}C$ | 39 | |
| I_D | Continuous Drain Current | $T_c = 80$ °C | 29 | A |
| I_{DM} | Pulsed Drain current | | 160 | |
| V_{GS} | Gate - Source Voltage | | ±20 | V |
| R _{DSon} | Drain - Source ON Resistance | | 70 | mΩ |
| P_{D} | Maximum Power Dissipation $T_c = 25^{\circ}C$ | | 250 | W |
| I_{AR} | Avalanche current (repetitive and non repetitive) | | 20 | A |
| E_{AR} | Repetitive Avalanche Energy | | 1 | mJ |
| E_{AS} | Single Pulse Avalanche Energy | | 1800 | 1113 |

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

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All ratings @ $T_j = 25$ °C unless otherwise specified

Electrical Characteristics

| Symbol | Characteristic | Test Conditions | Min | Тур | Max | Unit |
|---------------------|---------------------------------|---|-----|-----|------|------|
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{GS} = 0V, V_{DS} = 600V$ $T_j = 25^{\circ}C$ | | | 25 | μА |
| | | $V_{GS} = 0V, V_{DS} = 600V$ $T_j = 125^{\circ}C$ | | | 250 | |
| R _{DS(on)} | Drain – Source on Resistance | $V_{GS} = 10V, I_D = 39A$ | | | 70 | mΩ |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS} = V_{DS}$, $I_D = 2.7 \text{mA}$ | 2.1 | 3 | 3.9 | V |
| I_{GSS} | Gate – Source Leakage Current | $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ | | | ±100 | nA |

Dynamic Characteristics

| Symbol | Characteristic | Test Conditions | Min | Тур | Max | Unit |
|------------------|------------------------------|--|-----|------|-----|------|
| C_{iss} | Input Capacitance | $V_{GS} = 0V$ | | 7 | | |
| C_{oss} | Output Capacitance | $V_{DS} = 25V$ | | 2.56 | | nF |
| C_{rss} | Reverse Transfer Capacitance | f = 1MHz | | 0.21 | | |
| Q_{g} | Total gate Charge | $V_{GS} = 10V$ | | 259 | | |
| Q_{gs} | Gate – Source Charge | $V_{Bus} = 300V$ | | 29 | | nC |
| Q_{gd} | Gate – Drain Charge | $I_D = 39A$ | | 111 | | |
| $T_{d(on)}$ | Turn-on Delay Time | Inductive Switching @ 125°C | | 21 | | |
| $T_{\rm r}$ | Rise Time | $V_{GS} = 15V$ | | 30 | | na |
| $T_{d(off)}$ | Turn-off Delay Time | $\begin{array}{c} \begin{array}{c} \begin{array}{c} \begin{array}{c} \\ \\ \end{array} \end{array} \begin{array}{c} \begin{array}{c} \\ \\ \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \begin{array}{c} \\ \end{array} \begin{array}{c} \\ \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \begin{array}{c} \\ \end{array} \begin{array}{c} \\ \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \begin{array}{c} \\ \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \begin{array}{c} \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \begin{array}{c}$ | | 283 | | ns |
| T_{f} | Fall Time | $R_G = 5\Omega$ | | 84 | | |
| E_{on} | Turn-on Switching Energy | Inductive switching @ 25°C | | 670 | | 1 |
| E_{off} | Turn-off Switching Energy | $V_{GS} = 15V, V_{Bus} = 400V$ $I_D = 39A, R_G = 5\Omega$ | | 980 | | μJ |
| Eon | Turn-on Switching Energy | Inductive switching @ 125°C | | 1096 | | 1 |
| E_{off} | Turn-off Switching Energy | $V_{GS} = 15V, V_{Bus} = 400V$ $I_D = 39A, R_G = 5\Omega$ | | 1206 | | μJ |

Source - Drain diode ratings and characteristics

| Symbol | Characteristic | Test Conditions | | Min | Тур | Max | Unit |
|-----------------|------------------------------|-------------------------------------|---------------------|-----|-----|-----|------|
| I_{S} | Continuous Source current | | $Tc = 25^{\circ}C$ | | 39 | | Α |
| | (Body diode) | | $Tc = 80^{\circ}C$ | | 29 | | A |
| $ m V_{SD}$ | Diode Forward Voltage | $V_{GS} = 0V, I_S = -39A$ | | | | 1.2 | V |
| dv/dt | Peak Diode Recovery 1 | | | | | 6 | V/ns |
| t_{rr} | Reverse Recovery Time | $I_S = -39A$ | $T_j = 25^{\circ}C$ | | 580 | | ns |
| Q _{rr} | Reverse Recovery Charge | $V_R = 350V$ $di_S/dt = 100A/\mu s$ | $T_j = 25$ °C | | 23 | | μC |

• dv/dt numbers reflect the limitations of the circuit rather than the device itself.

 $I_S \leq \text{--} \ 39A \qquad di/dt \leq 100 A/\mu s \qquad V_R \leq V_{DSS} \qquad T_j \leq 150 ^{\circ} C$

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Thermal and package characteristics

| Symbol | Characteristic | | Min | Тур | Max | Unit | |
|-------------|---|---|-----|------|-----|------|-----|
| R_{thJC} | Junction to Case Thermal Resistance | | | | 0.5 | °C/W | |
| V_{ISOL} | RMS Isolation Voltage, any terminal to case $t = 1 \text{ min}$, | RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz | | 4000 | | | V |
| T_{J} | Operating junction temperature range | | -40 | | 150 | | |
| T_{STG} | Storage Temperature Range | | | -40 | | 125 | °C |
| $T_{\rm C}$ | Operating Case Temperature | | | -40 | | 100 | |
| Torque | Mounting torque | To heatsink | M4 | 2 | | 3 | N.m |
| Wt | Package Weight | • | | | | 80 | g |

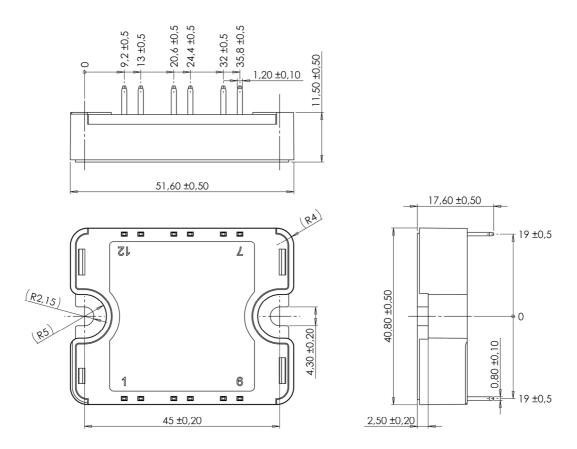
Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

| Symbol | Characteristic | Min | Тур | Max | Unit |
|-----------------|-----------------------------|-----|------|-----|------|
| R ₂₅ | Resistance @ 25°C | | 50 | | kΩ |
| B 25/85 | $T_{25} = 298.15 \text{ K}$ | | 3952 | | K |

$$R_{T} = \frac{R_{25}}{\exp \left[B_{25/85} \left(\frac{1}{T_{25}} - \frac{1}{T} \right) \right]} \quad \text{T: Thermistor temperature}$$

$$R_{T}: \text{ Thermistor value at T}$$

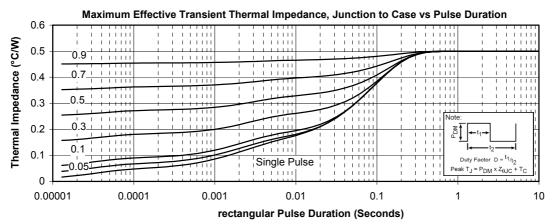
SP1 Package outline (dimensions in mm)

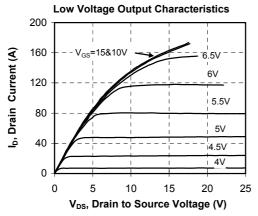


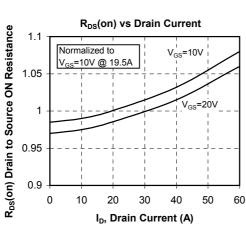
See application note 1904 - Mounting Instructions for SP1 Power Modules on www.microsemi.com

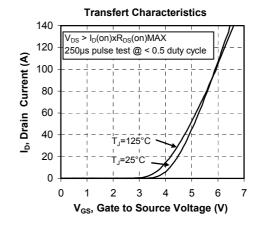


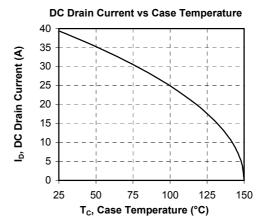
Typical Performance Curve



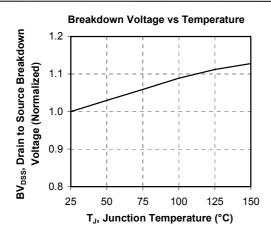


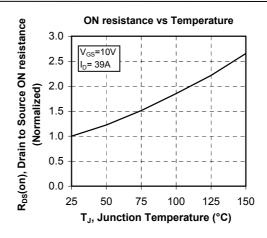


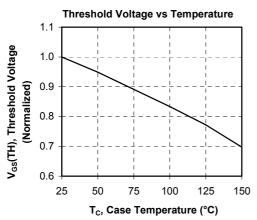


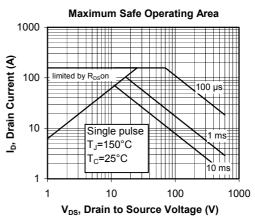


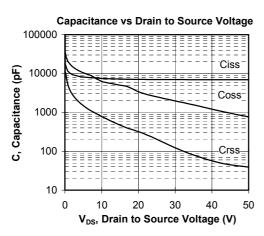


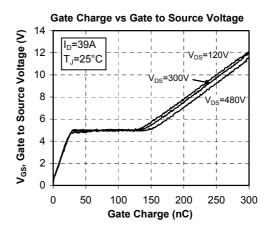




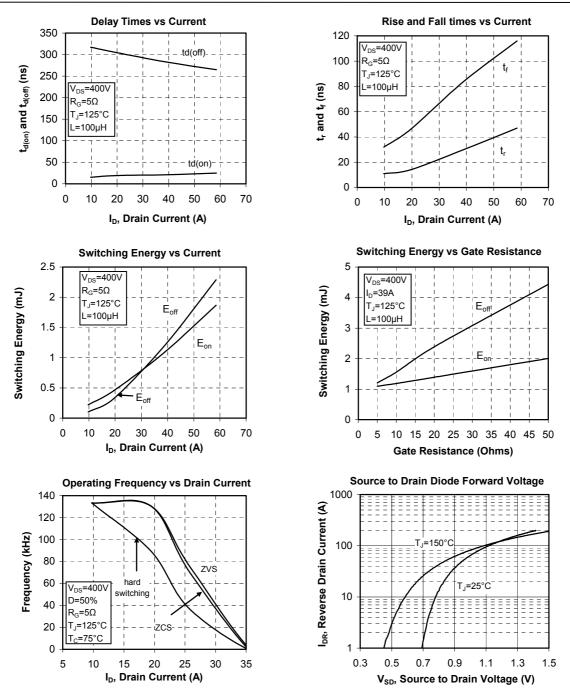












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